

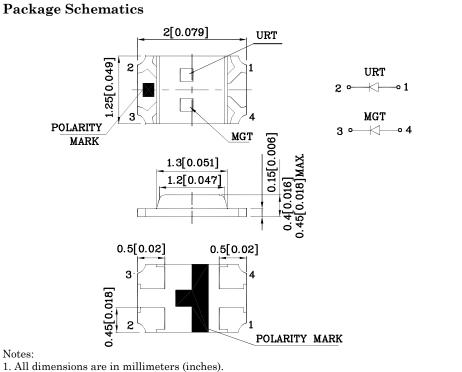
Part Number: XZURTMGT54W-4

2.0x1.25mm SMD CHIP LED LAMP

Features

- Ideal for indication light on hand held products
- Long life and robust package
- Variety of lens types and color choices available
- Package : 2000 pcs / reel
- \bullet Moisture sensitivity level : level 3
- \bullet RoHS compliant





2. Tolerance is $\pm 0.1(0.004")$ unless otherwise noted.

3. Specifications are subject to change without notice.

Absolute Maximum Ratings (T _A =25°C)		URT (GaAsP/ GaP)	MGT (GaP)	Unit
Reverse Voltage	$V_{\rm R}$	5	5	V
Forward Current	\mathbf{I}_{F}	30	25	mA
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	ifs	160	140	mA
Power Dissipation	P_{D}	75	62.5	mW
Operating Temperature	$T_{\rm A}$	-40 ~ +85		°C
Storage Temperature	Tstg	-40 ~ +85		-0

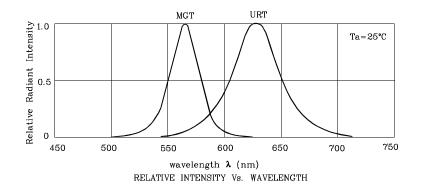
Operating Characteristics (T _A =25°C)		URT (GaAsP/ GaP)	MGT (GaP)	Unit
Forward Voltage (Typ.) (I _F =20mA)	$V_{\rm F}$	2	2.2	v
Forward Voltage (Max.) (I _F =20mA)	$V_{\rm F}$	2.5	2.5	v
Reverse Current (Max.) (V _R =5V)	I_R	10	10	uA
Wavelength of Peak Emission (Typ.) (I _F =20mA)	λP	627	565	nm
Wavelength of Dominant Emission (Typ.) (I _F =20mA)	λD	625	568	nm
Spectral Line Full Width At Half-Maximum (Typ.) (I _F =20mA)	$ riangle \lambda$	45	30	nm
Capacitance (Typ.) (V _F =0V, f=1MHz)	С	15	15	pF

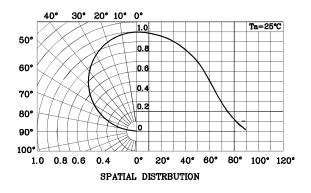
Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity (I _F =20mA) mcd		Wavelength nm λP	Viewing Angle 20 1/2
				min.	typ.		
XZURTMGT54W-4	Red	GaAsP/GaP	Water Clear	8	14	627	- 120°
	Green	GaP		8	14	565	

XDSB0166 V3 Layout: Maggie L.

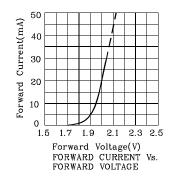


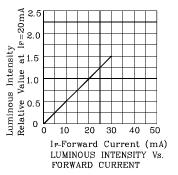
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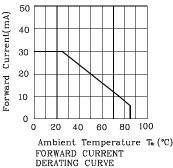


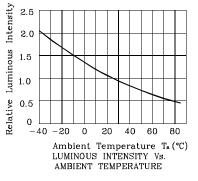


♦ URT

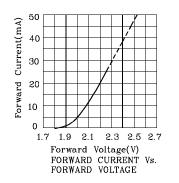


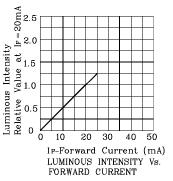


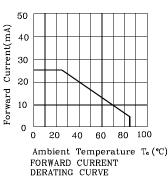


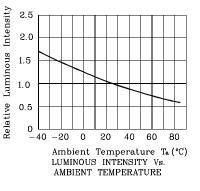


♦ MGT











LED is recommended for reflow soldering and soldering profile is shown below.

✤ The device has a single mounting surface. The device must be mounted according to the specifications.

300 (°C) 10 8 250 4°C/s 200 150~180°C 4°C/s max 150 Temperature 100 50 100 150 200 250 300 (sec) Tin Notes: 1. Maximum soldering temperature should not exceed 260°C 2. Recommended reflow temperature: 145°C-260°C

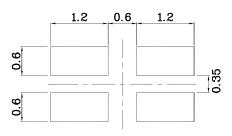
Reflow Soldering Profile for SMD Products (Pb-Free Components)

3. Do not put stress to the epoxy resin during high temperatures conditions

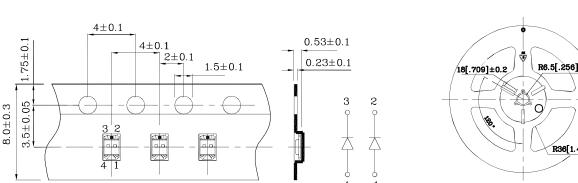
Tape Specification (Units : mm)

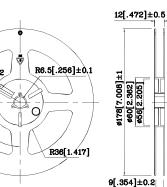
TAPE

Recommended Soldering Pattern (Units : mm; Tolerance: ± 0.1)



Reel Dimension





Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

1. Wavelength: +/-1nm

2. Luminous intensity / luminous flux: +/-15%

3. Forward Voltage: +/-0.1V $\,$

Note: Accuracy may depend on the sorting parameters.

Apr 15,2011



PACKING & LABEL SPECIFICATIONS

